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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Betano	
Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	21
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx150f128b-i-so

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

1.0 DEVICE OVERVIEW

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to documents listed in the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

BLOCK DIAGRAM

This document contains device-specific information for PIC32MX1XX/2XX 28/36/44-pin Family devices.

Figure 1-1 illustrates a general block diagram of the core and peripheral modules in the PIC32MX1XX/2XX 28/36/44-pin Family of devices.

Table 1-1 lists the functions of the various pins shown in the pinout diagrams.

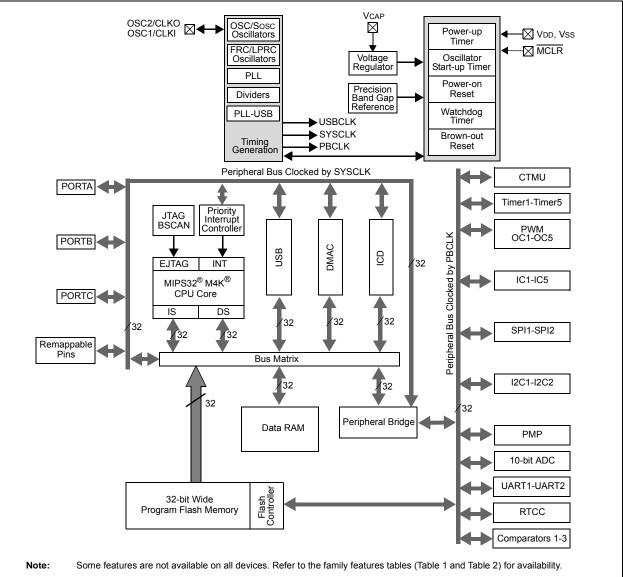


FIGURE 1-1:

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

NOTES:

TABLE 4-1: SFR MEMORY MAP

	Virtual A	ddress
Peripheral	Base	Offset Start
Watchdog Timer		0x0000
RTCC		0x0200
Timer1-5		0x0600
Input Capture 1-5		0x2000
Output Compare 1-5		0x3000
IC1 and IC2		0x5000
SPI1 and SPI2		0x5800
UART1 and UART2		0x6000
PMP		0x7000
ADC	0xBF80	0x9000
CVREF		0x9800
Comparator		0xA000
CTMU		0xA200
Oscillator		0xF000
Device and Revision ID		0xF220
Peripheral Module Disable		0xF240
Flash Controller		0xF400
Reset		0xF600
PPS		0xFA04
Interrupts		0x1000
Bus Matrix		0x2000
DMA	0xBF88	0x3000
USB		0x5050
PORTA-PORTC		0x6000
Configuration	0xBFC0	0x0BF0

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	_	_	—	_		_	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—	—	—	-
45.0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
15:8	—	_		_	_	S	RIPL<2:0>(1)	
7.0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_	_			VEC	<5:0> ⁽¹⁾		

REGISTER 7-2: INTSTAT: INTERRUPT STATUS REGISTER

Legend:

Legena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-11 Unimplemented: Read as '0'

- bit 10-8 SRIPL<2:0>: Requested Priority Level bits⁽¹⁾
 - 111-000 = The priority level of the latest interrupt presented to the CPU
- bit 7-6 Unimplemented: Read as '0'
- bit 5-0 VEC<5:0>: Interrupt Vector bits⁽¹⁾ 11111-00000 = The interrupt vector that is presented to the CPU
- Note 1: This value should only be used when the interrupt controller is configured for Single Vector mode.

D:/	Dit	Dit	D:	Dit	D'i	D''	Dir	Dit
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
31:24				IPTMF	<31:24>			
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
23.10				IPTMF	<23:16>			
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
10.0				IPTM	R<15:8>			
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7.0				IPTM	R<7:0>			

REGISTER 7-3: IPTMR: INTERRUPT PROXIMITY TIMER REGISTER

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 **IPTMR<31:0>:** Interrupt Proximity Timer Reload bits Used by the Interrupt Proximity Timer as a reload value when the Interrupt Proximity timer is triggered by an interrupt event.

TABLE 10-1: USB REGISTER MAP (CONTINUED)

ess		0									Bi	ts							(0
Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
5280	U1FRML ⁽³⁾	31:16	_	—	—	—	_	_	_	_	_	—	_	—	_	_	—	—	0000
5200		15:0	_	_	_	_	—	_	—	_				FRML<	7:0>				0000
5290	U1FRMH ⁽³⁾	31:16	_	—	—	—		—	—	_		—		—	—	—	_	—	0000
52.50	OTTRAIT	15:0	_	—	—	—	—	—	—			—		_	—		FRMH<2:0>	>	0000
52A0	U1TOK	31:16	_	—	—	—		—	—	_		—	_	_	—	—	_	—	0000
5270	UTTOR	15:0	_	—	—	—	—	—	—			PID	<3:0>			EP	<3:0>	-	0000
52B0	U1SOF	31:16	—	—			—			_	_	—	—	—	—	—	—	—	0000
5260	0130F	15:0	—			_	_		_					CNT<7	/:0>		-		0000
52C0	U1BDTP2	31:16	_	—		_			_	_	_	—	_	—	—	_	_	—	0000
5200	OIBDIF2	15:0	_	—		_			_	_				BDTPTR	H<7:0>				0000
52D0	U1BDTP3	31:16	_	—	—	—	—	—	—	_	_	—	_	_	—	—	—	—	0000
5200	OIBDIF3	15:0	_	—		_			_	_				BDTPTRI	J<7:0>				0000
52E0	U1CNFG1	31:16	_	—	—	—	—	—	—	_	_	—	_	_	—	—	—	—	0000
5210	UTCNI UT	15:0	_	_	—	—	—	—	—	_	UTEYE	UOEMON		USBSIDL	—	—	_	UASUSPND	0001
5300	U1EP0	31:16	_	_	—	—	—	—	—	_		—		_	—	—	_	—	0000
5500	UIEI U	15:0	_	_	—	—	—	—	—	_	LSPD	RETRYDIS		EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5310	U1EP1	31:16	_	_	—	—	—	—	—	_		—		_	—	—	_	—	0000
5510	UIEI I	15:0	_	_	—	—	—	—	—	_		—		EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5320	U1EP2	31:16	—	—	_	_	_	_	—	_	—	—	—	_	—	_	—	—	0000
0020	OTET 2	15:0	_	—		—	—		—	—		—	_	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5330	U1EP3	31:16	_	—		—	—	—	—			—	_	_	—	—		—	0000
0000	UTER 0	15:0	_	—		—	—		—	—		—	_	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5340	U1EP4	31:16	—	—	—	—	—	—	—	—	_	—	—	—	—	—		—	0000
0010	01EFT	15:0	—	—	—	—	—		—	_	—	—	—	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5350	U1EP5	31:16	—	—	—	—	—	—	—	—	_	—	—	—	—	—	—	—	0000
0000	01EI 0	15:0	—	—	—	—	—		—	_	—	—	—	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5360	U1EP6	31:16	—	—	—	—	—	—	—	—	_	—	—	—	—	—	—	—	0000
0000	0.2.0	15:0	_	—	_	_					_	—	_	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5370	U1EP7	31:16	—	—	—	—	—	—	—	—	_	—	—	—	—	—		—	0000
3070	01217	15:0	—	—	—	—	—	—	—	_	_	—	—	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5380	U1EP8	31:16	_	—	—	—			—	_	_	—	_	_	—	—	—	—	0000
5500	UILI U	15:0	—	-	_	_	—	_	_	_	_	—	—	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000

Legend: x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: With the exception of those noted, all registers in this table (except as noted) have corresponding CLR, SET and INV registers at their virtual address, plus an offset of 0x4, 0x8, and 0xC respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

2: This register does not have associated SET and INV registers.

3: This register does not have associated CLR, SET and INV registers.

4: Reset value for this bit is undefined.

TABLE 10-1: USB REGISTER MAP (CONTINUED)

ess							- /				Bit	s							
Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
5390	U1EP9	31:16	_	—	—	—	—	—	_	—		_	—	—	—	_	—	—	0000
5590	UIEF9	15:0			—	—	_	—	_	—			—	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5240	U1EP10	31:16	_	—	_	_			_	—	_	_	_	—	_	_	—	_	0000
53A0	UIEPIU	15:0		_	_	-	_	_	_	-	_	_	_	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
53B0	U1EP11	31:16		—	_	-	-	_	—	—	—	_	—	—	—	_	_	—	0000
53BU	UIEPII	15:0	_	—	_	_			_	—	_	_	_	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
53C0	U1EP12	31:16		—	_	-	-	_	—	—	—	_	—	—	—	_	_	—	0000
5500	UIEFIZ	15:0		—	_	-	-	_	—	—	—	_	—	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
53D0	U1EP13	31:16		—	_	-	-	_	—	—	—	_	—	—	—	_	_	—	0000
5500	UIEF 13	15:0		—	_	-	-	_	—	—	—	_	—	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5050		31:16		_	_		-	_	_	_	_	_	_	_	_	_	_	_	0000
53E0	U1EP14	15:0	_	_	_		_		_	_		_	_	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000
5050		31:16	_	_	_		_		_	_		_	_	—	_	_	_	_	0000
53F0	U1EP15	15:0	_	_	_	_	_	_	_	—			_	EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK	0000

Legend: x = unknown value on Reset; --- = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: With the exception of those noted, all registers in this table (except as noted) have corresponding CLR, SET and INV registers at their virtual address, plus an offset of 0x4, 0x8, and 0xC respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

2: This register does not have associated SET and INV registers.

3: This register does not have associated CLR, SET and INV registers.

4: Reset value for this bit is undefined.

11.1 Parallel I/O (PIO) Ports

All port pins have 10 registers directly associated with their operation as digital I/O. The data direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the latch (LATx) read the latch. Writes to the latch write the latch. Reads from the port (PORTx) read the port pins, while writes to the port pins write the latch.

11.1.1 OPEN-DRAIN CONFIGURATION

In addition to the PORTx, LATx, and TRISx registers for data control, some port pins can also be individually configured for either digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The open-drain feature allows the generation of outputs higher than VDD (e.g., 5V) on any desired 5V-tolerant pins by using external pull-up resistors. The maximum open-drain voltage allowed is the same as the maximum VIH specification.

See the **"Pin Diagrams"** section for the available pins and their functionality.

11.1.2 CONFIGURING ANALOG AND DIGITAL PORT PINS

The ANSELx register controls the operation of the analog port pins. The port pins that are to function as analog inputs must have their corresponding ANSEL and TRIS bits set. In order to use port pins for I/O functionality with digital modules, such as Timers, UARTs, etc., the corresponding ANSELx bit must be cleared.

The ANSELx register has a default value of 0xFFFF; therefore, all pins that share analog functions are analog (not digital) by default.

If the TRIS bit is cleared (output) while the ANSELx bit is set, the digital output level (VOH or VOL) is converted by an analog peripheral, such as the ADC module or Comparator module.

When the PORT register is read, all pins configured as analog input channels are read as cleared (a low level).

Pins configured as digital inputs do not convert an analog input. Analog levels on any pin defined as a digital input (including the ANx pins) can cause the input buffer to consume current that exceeds the device specifications.

11.1.3 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically this instruction would be a NOP.

11.1.4 INPUT CHANGE NOTIFICATION

The input change notification function of the I/O ports allows the PIC32MX1XX/2XX 28/36/44-pin Family devices to generate interrupt requests to the processor in response to a change-of-state on selected input pins. This feature can detect input change-of-states even in Sleep mode, when the clocks are disabled. Every I/O port pin can be selected (enabled) for generating an interrupt request on a change-of-state.

Five control registers are associated with the CN functionality of each I/O port. The CNENx registers contain the CN interrupt enable control bits for each of the input pins. Setting any of these bits enables a CN interrupt for the corresponding pins.

The CNSTATx register indicates whether a change occurred on the corresponding pin since the last read of the PORTx bit.

Each I/O pin also has a weak pull-up and a weak pull-down connected to it. The pull-ups act as a current source or sink source connected to the pin, and eliminate the need for external resistors when push-button or keypad devices are connected. The pull-ups and pull-downs are enabled separately using the CNPUx and the CNPDx registers, which contain the control bits for each of the pins. Setting any of the control bits enables the weak pull-ups and/or pull-downs for the corresponding pins.

Note: Pull-ups and pull-downs on change notification pins should always be disabled when the port pin is configured as a digital output.

An additional control register (CNCONx) is shown in Register 11-3.

11.2 CLR, SET and INV Registers

Every I/O module register has a corresponding CLR (clear), SET (set) and INV (invert) register designed to provide fast atomic bit manipulations. As the name of the register implies, a value written to a SET, CLR or INV register effectively performs the implied operation, but only on the corresponding base register and only bits specified as '1' are modified. Bits specified as '0' are not modified.

Reading SET, CLR and INV registers returns undefined values. To see the affects of a write operation to a SET, CLR, or INV register, the base register must be read.

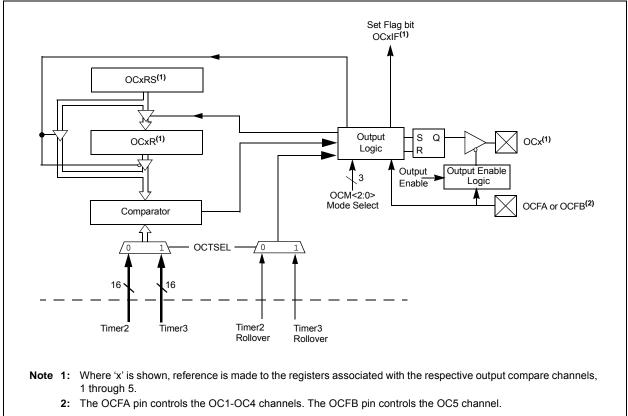
16.0 OUTPUT COMPARE

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 16. "Output Compare" (DS60001111), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Output Compare module is used to generate a single pulse or a train of pulses in response to selected time base events. For all modes of operation, the Output Compare module compares the values stored in the OCxR and/or the OCxRS registers to the value in the selected timer. When a match occurs, the Output Compare module generates an event based on the selected mode of operation. The following are some of the key features:

- · Multiple Output Compare Modules in a device
- Programmable interrupt generation on compare event
- Single and Dual Compare modes
- Single and continuous output pulse generation
- Pulse-Width Modulation (PWM) mode
- Hardware-based PWM Fault detection and automatic output disable
- Can operate from either of two available 16-bit time bases or a single 32-bit time base





REGISTER 18-2: I2CxSTAT: I²C STATUS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24		-	_	-	—		_	_
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	_	_	_	_	—	_	-
15.0	R-0, HSC	R-0, HSC	U-0	U-0	U-0	R/C-0, HS	R-0, HSC	R-0, HSC
15:8	ACKSTAT	TRSTAT	-	-	_	BCL	GCSTAT	ADD10
7:0	R/C-0, HS	R/C-0, HS	R-0, HSC	R/C-0, HSC	R/C-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
7:0	IWCOL	I2COV	D_A	Р	S	R_W	RBF	TBF

Legend:	HS = Set in hardware	HSC = Hardware set/clea	red
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	C = Clearable bit

bit 31-16 Unimplemented: Read as '0'

bit 15 ACKSTAT: Acknowledge Status bit (when operating as I²C master, applicable to master transmit operation) 1 = Acknowledge was not received from slave 0 = Acknowledge was received from slave Hardware set or clear at end of slave Acknowledge. bit 14 **TRSTAT:** Transmit Status bit (when operating as I²C master, applicable to master transmit operation) 1 = Master transmit is in progress (8 bits + ACK) 0 = Master transmit is not in progress Hardware set at beginning of master transmission. Hardware clear at end of slave Acknowledge. bit 13-11 Unimplemented: Read as '0' bit 10 BCL: Master Bus Collision Detect bit 1 = A bus collision has been detected during a master operation 0 = No collisionHardware set at detection of bus collision. This condition can only be cleared by disabling (ON bit = 0) and re-enabling (ON bit = 1) the module. bit 9 GCSTAT: General Call Status bit 1 = General call address was received 0 = General call address was not received Hardware set when address matches general call address. Hardware clear at Stop detection. bit 8 ADD10: 10-bit Address Status bit 1 = 10-bit address was matched 0 = 10-bit address was not matched Hardware set at match of 2nd byte of matched 10-bit address. Hardware clear at Stop detection.

bit 7 IWCOL: Write Collision Detect bit

1 = An attempt to write the I2CxTRN register failed because the I ² C module is busy	
0 = No collision	

Hardware set at occurrence of write to I2CxTRN while busy (cleared by software).

bit 6 I2COV: Receive Overflow Flag bit

1 = A byte was received while the I2CxRCV register is still holding the previous byte 0 = No overflow

Hardware set at attempt to transfer I2CxRSR to I2CxRCV (cleared by software).

bit 5 **D_A:** Data/Address bit (when operating as I²C slave)

- 1 = Indicates that the last byte received was data
- 0 = Indicates that the last byte received was device address

Hardware clear at device address match. Hardware set by reception of slave byte.

NOTES:

$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Bit 24/16/8/0	Bit 25/17/9/1	Bit 26/18/10/2	Bit 27/19/11/3	Bit 28/20/12/4	Bit 29/21/13/5	Bit 30/22/14/6	Bit 31/23/15/7	Bit Range
Image: How provided with the system HR10<1:0> HR01<3:0> 23:16 U-0 R/W-x R/W-x R/W-x R/W-x R/W-x 23:16 — MIN10<2:0> MIN01<3:0> MIN01<3:0> 15:8 U-0 R/W-x R/W-x R/W-x R/W-x R/W-x 15:8 — SEC10<2:0> SEC01<3:0> SEC01<3:0>	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	U-0	U-0	04.04
23:16 — MIN10<2:0> MIN01<3:0> 15:8 U-0 R/W-x R/W-x R/W-x R/W-x R/W-x 15:8 — SEC10<2:0> SEC01<3:0> SEC01<3:0>		<3:0>	HR01		<1:0>	HR10	—	_	31:24
U-0 R/W-x R	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	U-0	00.40
15:8 — SEC10<2:0> SEC01<3:0>		<3:0>	MIN01			MIN10<2:0>		_	23:16
	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	U-0	45.0
		<3:0>	SEC01			SEC10<2:0>		_	15:8
	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	7.0
7:0	_		_	_	_	_	_	_	7:0

REGISTER 21-5: ALRMTIME: ALARM TIME VALUE REGISTER

R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 31-30 Unimplemented: Read as '0'

bit 29-28 HR10<1:0>: Binary Coded Decimal value of hours bits, 10s place digit; contains a value from 0 to 2

bit 27-24 **HR01<3:0>:** Binary Coded Decimal value of hours bits, 1s place digit; contains a value from 0 to 9 bit 23 **Unimplemented:** Read as '0'

bit 22-20 MIN10<2:0>: Binary Coded Decimal value of minutes bits, 10s place digit; contains a value from 0 to 5

bit 19-16 **MIN01<3:0>:** Binary Coded Decimal value of minutes bits, 1s place digit; contains a value from 0 to 9 bit 15 **Unimplemented:** Read as '0'

bit 14-12 SEC10<2:0>: Binary Coded Decimal value of seconds bits, 10s place digit; contains a value from 0 to 5

bit 11-8 **SEC01<3:0>:** Binary Coded Decimal value of seconds bits, 1s place digit; contains a value from 0 to 9

bit 7-0 Unimplemented: Read as '0'

PIC32MX1XX/2XX 28/36/44-PIN FAMILY



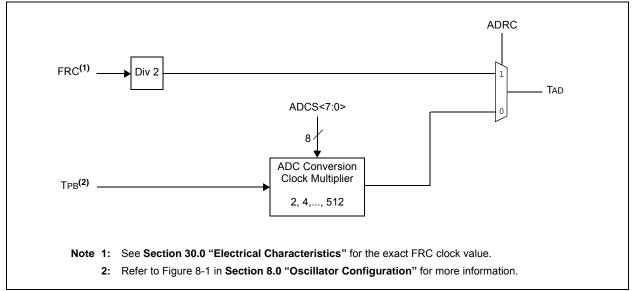


TABLE 26-2: PERIPHERAL MODULE DISABLE REGISTER MAP

ess			Bits												6				
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
F0.40	PMD1	31:16	—	—	_	—	_	_	_	—	—	—	—	—	_	—	—	—	0000
F240	FIVIDI	15:0	-			CVRMD	Ι			CTMUMD	—	-		-			—	AD1MD	0000
5250	PMD2	31:16	—	—		—	_	_		—	—	—	—	—	_	—	—	—	0000
F250	FIVIDZ	15:0	-			—	Ι			—	—	-		-		CMP3MD	CMP2MD	CMP1MD	0000
F260	PMD3	31:16	_	-		_	-			_	_		_	OC5MD	OC4MD	OC3MD	OC2MD	OC1MD	0000
F200	FIVIDS	15:0	_	-		_	-			_	_		_	IC5MD	IC4MD	IC3MD	IC2MD	IC1MD	0000
F270	PMD4	31:16	_	-		_	-			_	_		_	-	_	_	—	_	0000
F270	F IVID4	15:0	_	-		_	-			_	_		_	T5MD	T4MD	T3MD	T2MD	T1MD	0000
F280	PMD5	31:16	_	-		_	-			USB1MD	_		_	-	_	_	I2C1MD	I2C1MD	0000
F200	FIVIDS	15:0	_	-		_	-		SPI2MD	SPI1MD	_		_	-	_	_	U2MD	U1MD	0000
F200	PMD6	31:16	_	—		—	_	_		_	—	_	—	—	_	—	—	PMPMD	0000
F290	I WD0	15:0	—	_	_	—	_	_	-	—	—	_	_	_	_	_	REFOMD	RTCCMD	0000

Legend: x = unknown value on Reset; -- = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

DC CHA	RACTERIS	TICS	$\begin{array}{llllllllllllllllllllllllllllllllllll$								
Param. No.	Typical ⁽²⁾	Max.	Units	Conditions							
Power-Down Current (IPD) (Notes 1, 5)											
DC40k	44	70	μA	-40°C							
DC40I	44	70	μA	+25°C	Base Power-Down Current						
DC40n	168	259	μA	+85°C							
DC40m	335	536	μA	+105°C							
Module Differential Current											
DC41e	5	20	μA	3.6V	Watchdog Timer Current: AIWDT (Note 3)						
DC42e	23	50	μA	3.6V	RTCC + Timer1 w/32 kHz Crystal: ΔIRTCC (Note 3)						
DC43d	1000	1100	μA	3.6V	ADC: Aladc (Notes 3,4)						

TABLE 30-7: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

Note 1: The test conditions for IPD current measurements are as follows:

Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)

OSC2/CLKO is configured as an I/O input pin

• USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8

• CPU is in Sleep mode, and SRAM data memory Wait states = 1

• No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is set

• WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled

• All I/O pins are configured as inputs and pulled to Vss

• MCLR = VDD

• RTCC and JTAG are disabled

2: Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

- **3:** The ∆ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.
- 4: Test conditions for ADC module differential current are as follows: Internal ADC RC oscillator enabled.
- 5: IPD electrical characteristics for devices with 256 KB Flash are only provided as Preliminary information.

DC CHARACTERISTICS				otherwi	se state	nditions: 2.3V to 3.6V d) $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp		
Param.	. Symbol Characteristic Min.				Max.	Units	Conditions	
DO10	Vol	Output Low Voltage	_	_	0.4	V	$\text{IOL} \leq 10 \text{ mA, VDD} = 3.3 \text{V}$	
		Output High Voltage	1.5(1)	_	_	V	IOH \geq -14 mA, VDD = 3.3V	
DO20	Vон	I/O Pins	2.0 ⁽¹⁾	_	_		IOH \geq -12 mA, VDD = 3.3V	
D020	VOH		2.4	_	_	v	IOH \geq -10 mA, VDD = 3.3V	
			3.0(1)	—	—		$IOH \ge -7 \text{ mA}, \text{ VDD} = 3.3 \text{V}$	

TABLE 30-10: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

Note 1: Parameters are characterized, but not tested.

TABLE 30-11: ELECTRICAL CHARACTERISTICS: BOR

				$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Param. No.	Symbol	Characteristics	Min. ⁽¹⁾	Typical	Max.	Units	Conditions			
BO10	VBOR	BOR Event on VDD transition high-to-low ⁽²⁾	2.0	—	2.3	V	_			

Note 1: Parameters are for design guidance only and are not tested in manufacturing.

2: Overall functional device operation at VBORMIN < VDD < VDDMIN is tested, but not characterized. All device Analog modules, such as ADC, etc., will function, but with degraded performance below VDDMIN.

DC CHA		STICS	$\begin{array}{l} \mbox{Standard Operating Conditions (see Note 4): 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Comments		
D300	VIOFF	Input Offset Voltage	-	±7.5	±25	mV	AVDD = VDD, AVSS = VSS		
D301	VICM	Input Common Mode Voltage	0	-	Vdd	V	AVDD = VDD, AVss = Vss (Note 2)		
D302	CMRR	Common Mode Rejection Ratio	55	—	_	dB	Max VICM = (VDD - 1)V (Note 2)		
D303A	TRESP	Large Signal Response Time	_	150	400	ns	AVDD = VDD, AVSS = VSS (Note 1,2)		
D303B	TSRESP	Small Signal Response Time	-	1	_	μS	This is defined as an input step of 50 mV with 15 mV of overdrive (Note 2)		
D304	ON2ov	Comparator Enabled to Output Valid	_	_	10	μs	Comparator module is configured before setting the comparator ON bit (Note 2)		
D305	IVREF	Internal Voltage Reference	1.14	1.2	1.26	V	—		
D312	TSET	Internal Comparator Voltage DRC Reference Setting time	—	—	10	μs	(Note 3)		

TABLE 30-13: COMPARATOR SPECIFICATIONS

Note 1: Response time measured with one comparator input at (VDD – 1.5)/2, while the other input transitions from Vss to VDD.

2: These parameters are characterized but not tested.

3: Settling time measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'. This parameter is characterized, but not tested in manufacturing.

4: The Comparator module is functional at VBORMIN < VDD < VDDMIN, but with degraded performance. Unless otherwise stated, module functionality is tested, but not characterized.

АС СНА	RACTERI	ISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ & -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$						
Param. No.	Symbol	Characteristics	Min.	Typical ⁽¹⁾	Max.	Units	Conditions		
OS10	Fosc	External CLKI Frequency (External clocks allowed only in EC and ECPLL modes)	DC 4		40 40	MHz MHz	EC (Note 4) ECPLL (Note 3)		
OS11		Oscillator Crystal Frequency	3	—	10	MHz	XT (Note 4)		
OS12			4	—	10	MHz	XTPLL (Notes 3,4)		
OS13			10	—	25	MHz	HS (Note 5)		
OS14			10	-	25	MHz	HSPLL (Notes 3,4)		
OS15			32	32.768	100	kHz	Sosc (Note 4)		
OS20	Tosc	Tosc = 1/Fosc = Tcy (Note 2)	—	—	_	—	See parameter OS10 for Fosc value		
OS30	TosL, TosH	External Clock In (OSC1) High or Low Time	0.45 x Tosc	-	—	ns	EC (Note 4)		
OS31	TosR, TosF	External Clock In (OSC1) Rise or Fall Time	—	—	0.05 x Tosc	ns	EC (Note 4)		
OS40	Тоѕт	Oscillator Start-up Timer Period (Only applies to HS, HSPLL, XT, XTPLL and Sosc Clock Oscillator modes)	_	1024	_	Tosc	(Note 4)		
OS41	TFSCM	Primary Clock Fail Safe Time-out Period	—	2	_	ms	(Note 4)		
OS42	Gм	External Oscillator Transconductance (Primary Oscillator only)	—	12	—	mA/V	VDD = 3.3V, TA = +25°C (Note 4)		

TABLE 30-17: EXTERNAL CLOCK TIMING REQUIREMENTS

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are characterized but are not tested.

2: Instruction cycle period (Tcr) equals the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin.

3: PLL input requirements: 4 MHz \leq FPLLIN \leq 5 MHz (use PLL prescaler to reduce FOSC). This parameter is characterized, but tested at 10 MHz only at manufacturing.

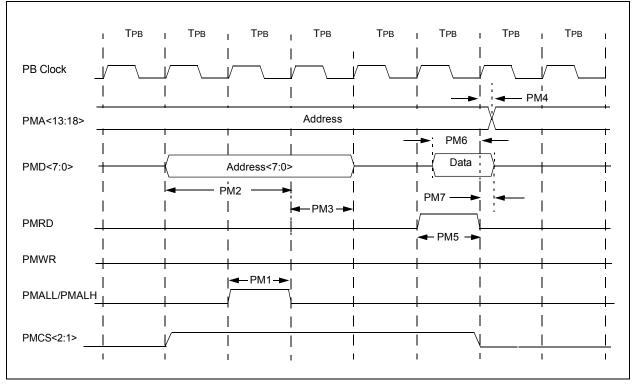
4: This parameter is characterized, but not tested in manufacturing.

TABLE 30-37: PARALLEL SLAVE PORT REQUIREMENTS

AC CH	ARACTE	RISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$						
Para m.No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур.	Max.	Units	Conditions		
PS1	TdtV2wr H	Data In Valid before \overline{WR} or \overline{CS} Inactive (setup time)	20			ns	_		
PS2	TwrH2dt I	WR or CS Inactive to Data-In Invalid (hold time)	40	—	_	ns	_		
PS3	TrdL2dt V	RD and CS Active to Data-Out Valid	_	—	60	ns	_		
PS4	TrdH2dtl	RD Active or CS Inactive to Data-Out Invalid	0	—	10	ns	_		
PS5	Tcs	CS Active Time	Трв + 40	_	_	ns	—		
PS6	Twr	WR Active Time	Трв + 25	_	_	ns	—		
PS7	Trd	RD Active Time	Трв + 25	_	—	ns	—		

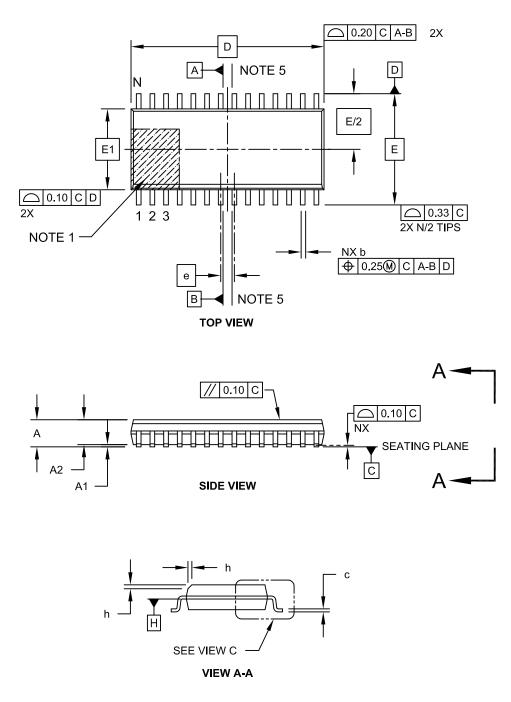
Note 1: These parameters are characterized, but not tested in manufacturing.

FIGURE 30-21: PARALLEL MASTER PORT READ TIMING DIAGRAM



28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



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NOTES: